

3.0mmx1.0 mm RIGHT ANGLE INFRARED **EMITTING DIODE**

Part Number: KPA-3010F3C

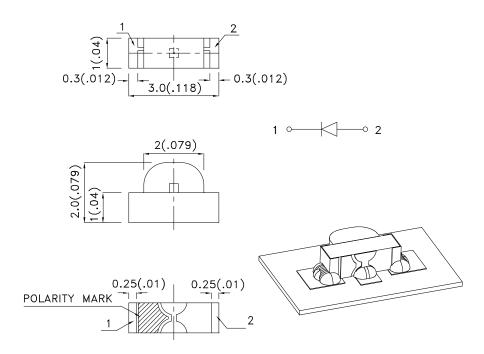
Features

- 3.0mmx1.0mm right angle SMT LED, 2.0mm thickness.
- Mechanically and spectrally matched to phototransistor.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.



SPEC NO: DSAA1131 **REV NO: V.15A** DATE: DEC/04/2011 PAGE: 1 OF 5 CHECKED: Allen Liu APPROVED: WYNEC DRAWN: Y.H.Wu ERP: 1203000562

Selection Guide

| Part No. | Dice | Lens Type | Po (mW/sr) [2] @ 20mA | | Viewing Angle [1] |
|-------------|-----------|-------------|--------------------------|------|----------------------|
| | | - | Min. | Тур. | 201/2 |
| KPA-3010F3C | F3 (GaAs) | Matan Class | 1.2 | 3 | - 120° |
| | | Water Clear | *0.8 | *2 | |

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Electrical / Optical Characteristics at TA=25°C

| Parameter | P/N | Symbol | Тур. | Max. | Units | Test Conditions | |
|--------------------------|-----|--------|------|------|-------|---------------------|--|
| Forward Voltage [1] | F3 | VF | 1.2 | 1.6 | V | IF=20mA | |
| Reverse Current | F3 | lr | | 10 | uA | V _R = 5V | |
| Capacitance | F3 | С | 90 | | pF | VF=0V;f=1MHz | |
| Peak Spectral Wavelength | F3 | λP | 940 | | nm | IF=20mA | |
| Spectral Bandwidth | F3 | Δλ1/2 | 50 | | nm | I=20mA | |

Note: 1.Forward Voltage: +/-0.1V.

 $2. \ Wavelength \ value \ is \ traceable \ to \ the \ CIE127-2007 \ compliant \ national \ standards.$

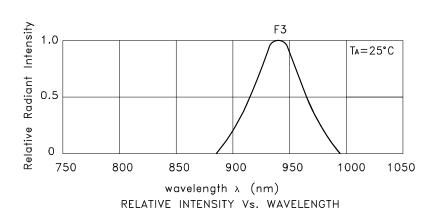
Absolute Maximum Ratings at TA=25°C

| Abbolato maximum ratingo at 171 20 0 | | | | | | | |
|--------------------------------------|--|--|--|--|--|--|--|
| Units | | | | | | | |
| mW | | | | | | | |
| mA | | | | | | | |
| A | | | | | | | |
| V | | | | | | | |
| °C | | | | | | | |
| °C | | | | | | | |
| | | | | | | | |

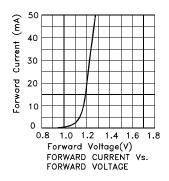
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

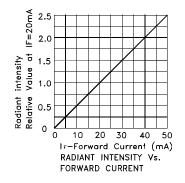
SPEC NO: DSAA1131 **REV NO: V.15A** DATE: DEC/04/2011 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.H.Wu ERP: 1203000562

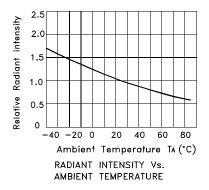
Radiant Intensity/ luminous flux: +/-15%.
 *Radiant Intensity value is traceable to the CIE127-2007 compliant national standards.

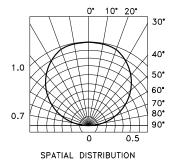


KPA-3010F3C









PAGE: 3 OF 5

ERP: 1203000562

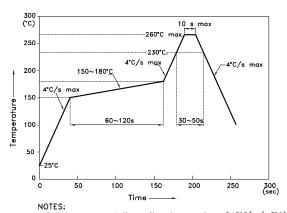
SPEC NO: DSAA1131 REV NO: V.15A DATE: DEC/04/2011

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KPA-3010F3C

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

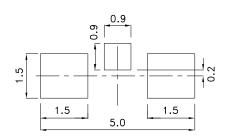
Reflow Soldering Profile For Lead-free SMT Process.



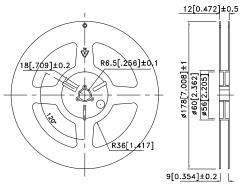
- 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

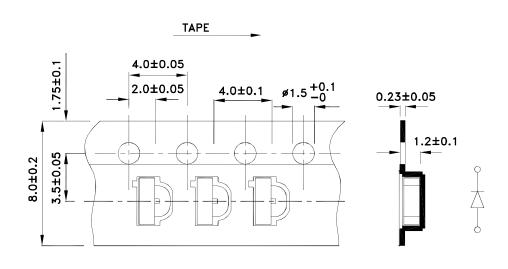
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



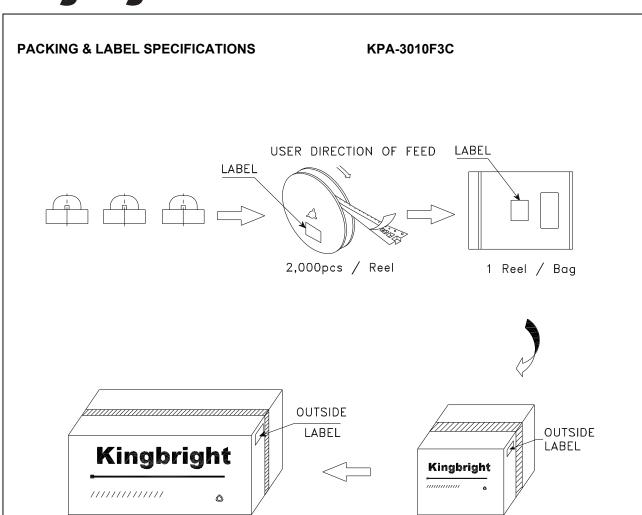
Reel Dimension

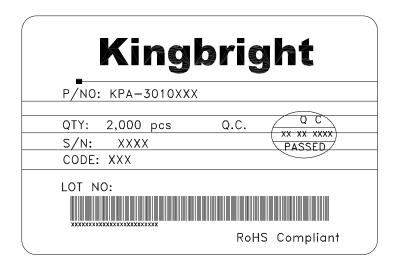


Tape Specifications (Units: mm)



SPEC NO: DSAA1131 **REV NO: V.15A DATE: DEC/04/2011** PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.H.Wu ERP: 1203000562





SPEC NO: DSAA1131 APPROVED: WYNEC REV NO: V.15A CHECKED: Allen Liu

60K / 56# BOX

DATE: DEC/04/2011 DRAWN: Y.H.Wu

30K / 55# Box

PAGE: 5 OF 5 ERP: 1203000562